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Dong-Weon Lee
④JNU

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- Ministry of Science and Technology of China
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From Concept to Product---a business model for MEMS	53
——General Manager IMEC China Teng Gao	
Applications of Micro/Nanotechnology in MEMS Devices and Microsystems Packaging	54
——Nanyang Technological University, Singapore Jianmin Miao	
Advanced MEMS Manufacturing Technology	67
——SUSS MicroTec Erwin Hell	
SMEC's Advanced and Low-cost Lithography Tool for MEMS Manufacturing and Application	92
——Marketing Director of Shanghai Micro Electronics Equipment Co., Ltd. Yonghui Chen	
Markets and Players for Micro and Nanotechnology in Europe: from Medical Devices to Green MEMS	105
——Managing Director of IVAM Microtechnology Network Uwe Kleinkes	
Nano Imprint Lithography for improved performance of HB-LEDs	122
——Business Development Manager EV Group Thomas Uhrmann	
A Unique Approach for ashing and etching of MEMS	124
——General Manager R&D, R3T GmbH, Rapid Reactive Radicals Technology Josef Mathuni	
Advanced cantilever devices for a novel SPM system	140
——Chonnam national University, Korea Dong-Weon Lee	
The developments of grinding process and nano-/microfine grinding equipments	157
——General Manager of Beijing Retsch Topway Technology Co.,Ltd Pingang Feng	
Sophisticated Interconnect and Cap Wafer Technology for advanced 3D Wafer Level Packaging	193
——Manager of R & D and Clean room Plan Optik AG Steffen Janßen	
Intelligent Contextual Sensing	202
——Director, Asia Pacific Center Freescale Semiconductor (China) Ltd Benjamin Tan	